





100V NPN HIGH VOLTAGE TRANSISTOR IN TO252

Features

- BV_{CEO} > 100V
- I_C = 3A high Continuous Collector Current
- I_{CM} = 5A Peak Pulse Current
- Ideal for Power Switching or Amplification Applications
- Complementary PNP Type: MJD32C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

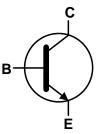
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.34 grams (Approximate)

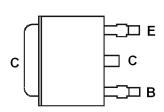




Top View



Device Schematic



Pin Out Configuration Top View

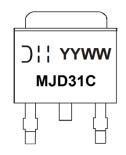
Ordering Information (Note 4)

| Product | Compliance | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|-----------|------------|---------|--------------------|-----------------|-------------------|
| MJD31C-13 | AEC-Q101 | MJD31C | 13 | 16 | 2,500 |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



MJD31C = Product Type Marking Code

| Sit = Manufacturers' code marking
| YYWW = Date Code Marking
| YY = Last Digit of Year (ex: 16 = 2016)
| WW = Week Code (01 - 53)



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 100 | V |
| Collector-Emitter Voltage | V _{CEO} | 100 | V |
| Emitter-Base Voltage | V _{EBO} | 6 | V |
| Continuous Collector Current | Ic | 3 | A |
| Peak Pulse Collector Current | I _{CM} | 5 | A |
| Continuous Base Current | I _B | 1 | A |
| Power Dissipation | P _D | 15 | W |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|---|---------------------|----------------|------|------|--|
| | (Note 5) | | 3.9 | | |
| Power Dissipation | (Note 6) | P _D | 2.1 | W | |
| | (Note 7) | | 1.6 | 1 | |
| | (Note 5) | | 32 | | |
| Thermal Resistance, Junction to Ambient Air | (Note 6) | $R_{	heta JA}$ | 59 | °C/W | |
| | (Note 7) | | 80 | | |
| Thermal Resistance, Junction to Leads | (Note 8) | $R_{	hetaJL}$ | 8.4 | | |
| Operating and Storage Temperature Range | T_{J} , T_{STG} | -55 to +150 | °C | | |

ESD Ratings (Note 9)

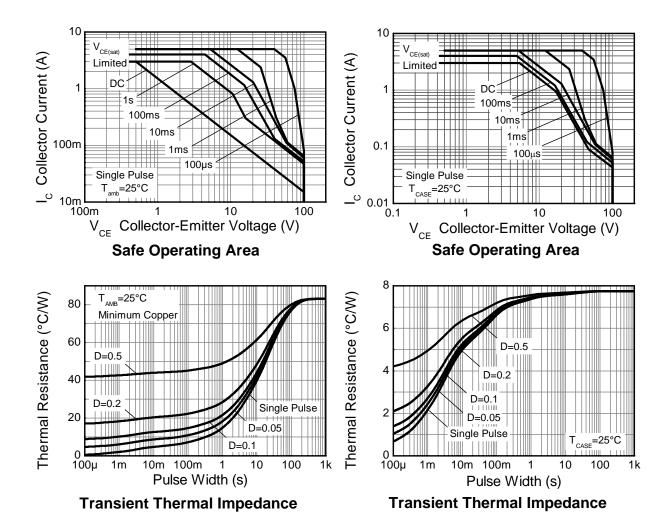
| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

Notes:

- 5. For a device mounted with the exposed collector pad on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as note (5), except mounted on $\bar{2}5\text{mm}$ x 25mm 1oz copper.
- 7. Same as note (5), except mounted on minimum recommended pad (MRP) layout.
- 8. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|-----|-----|-----|------|---|
| Collector-Emitter Breakdown Voltage (Note 10) | BV _{CEO} | 100 | _ | _ | V | $I_C = 30 \text{mA}, I_B = 0$ |
| Collector Cut-off Current | ICEO | _ | _ | 1 | μΑ | $V_{CB} = 60V, I_B = 0$ |
| Collector Cut-off Current | I _{CES} | _ | _ | 1 | μΑ | $V_{CE} = 100V, V_{EB} = 0$ |
| Emitter Cut-off Current | I _{EBO} | _ | _ | 1 | μΑ | $V_{EB} = 5V, I_{C} = 0$ |
| Collector-Emitter Saturation Voltage (Note 10) | V _{CE(sat)} | _ | _ | 1.2 | V | $I_C = 3.0A$, $I_B = 375mA$ |
| Base-Emitter Turn-On Voltage (Note 10) | V _{BE(on)} | _ | _ | 1.8 | V | $I_C = 3A$, $V_{CE} = 4V$ |
| DC Current Gain (Note 10) | h | 25 | | _ | | $V_{CE} = 4V$, $I_C = 1A$ |
| DC Current Gain (Note 10) | h _{FE} | 10 | | 50 | | $V_{CE} = 4V$, $I_C = 3A$ |
| Current Signal Current Gain | H _{fe} | 20 | _ | _ | _ | $V_{CE} = 10V, I_{C} = 0.5A, f = 1KHz$ |
| Current Gain-Bandwidth Product | f _T | 3.0 | | _ | MHz | $I_C = 500 \text{mA}, V_{CE} = 10 \text{V}, f = 1 \text{MHz}$ |

Note: 10. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

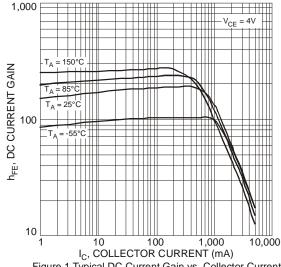


Figure 1 Typical DC Current Gain vs. Collector Current

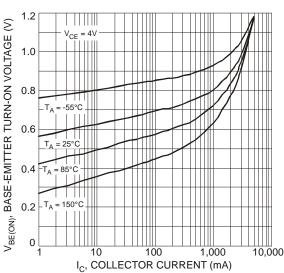


Figure 3 Typical Base-Emitter Turn-On Voltage vs. Collector Current

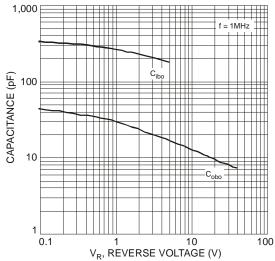
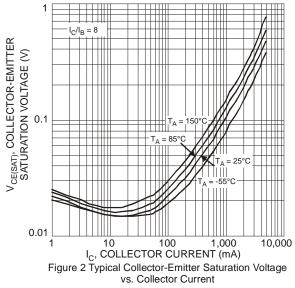


Figure 5 Typical Capacitance Characteristics



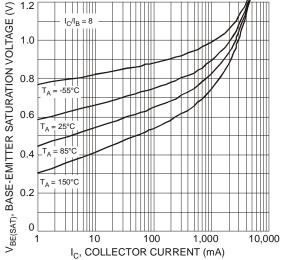
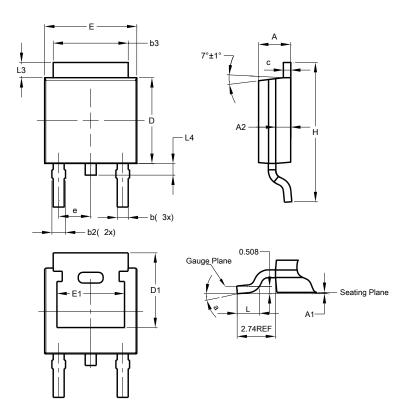


Figure 4 Typical Base-Emitter Saturation Voltage vs. Collector Current



Package Outline Dimensions

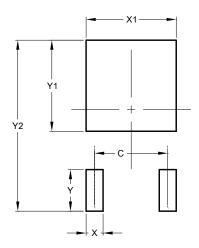
Please see http://www.diodes.com/package-outlines.html for the latest version.



| TO252 (DPAK) | | | | |
|----------------------|------|-------|-------|--|
| Dim | Min | Max | Тур | |
| Α | 2.19 | 2.39 | 2.29 | |
| A1 | 0.00 | 0.13 | 0.08 | |
| A2 | 0.97 | 1.17 | 1.07 | |
| b | 0.64 | 0.88 | 0.783 | |
| b2 | 0.76 | 1.14 | 0.95 | |
| b3 | 5.21 | 5.46 | 5.33 | |
| С | 0.45 | 0.58 | 0.531 | |
| D | 6.00 | 6.20 | 6.10 | |
| D1 | 5.21 | - | - | |
| е | - | - | 2.286 | |
| Е | 6.45 | 6.70 | 6.58 | |
| E1 | 4.32 | - | - | |
| Н | 9.40 | 10.41 | 9.91 | |
| L | 1.40 | 1.78 | 1.59 | |
| L3 | 0.88 | 1.27 | 1.08 | |
| L4 | 0.64 | 1.02 | 0.83 | |
| а | 0° | 10° | - | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 4.572 |
| Х | 1.060 |
| X1 | 5.632 |
| Υ | 2.600 |
| Y1 | 5.700 |
| Y2 | 10.700 |

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.

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